



IBM Systems and Technology Group

Extraction of Scalable HiCuM Parameters and Verification for Advanced SiGe HBTs

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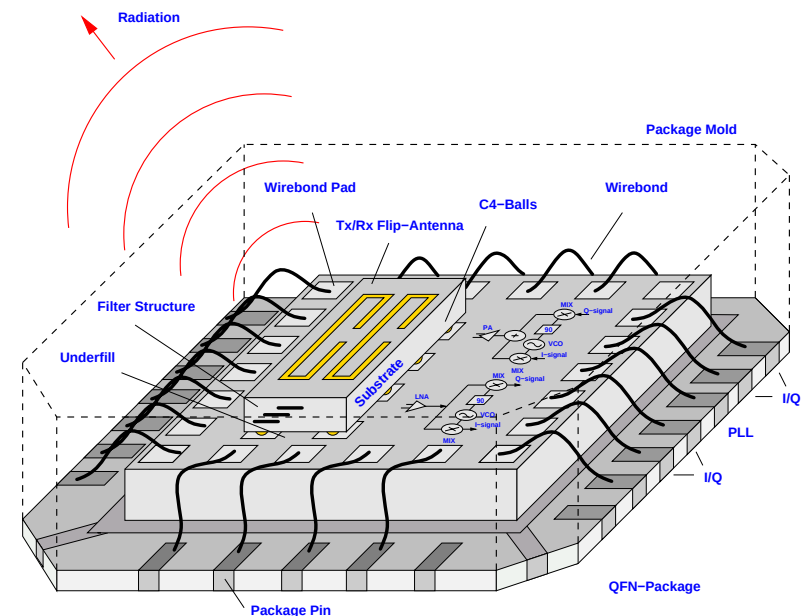
Outline

- **Motivation**
- **Modeling Methodology**
- **Parameter Extraction Procedure**
- **Results**
 - DC
 - Small Signal
 - High-Frequency Noise
 - Distortion
- **Summary**

200 GHz SiGe HBT Technology: Applications in the W-band

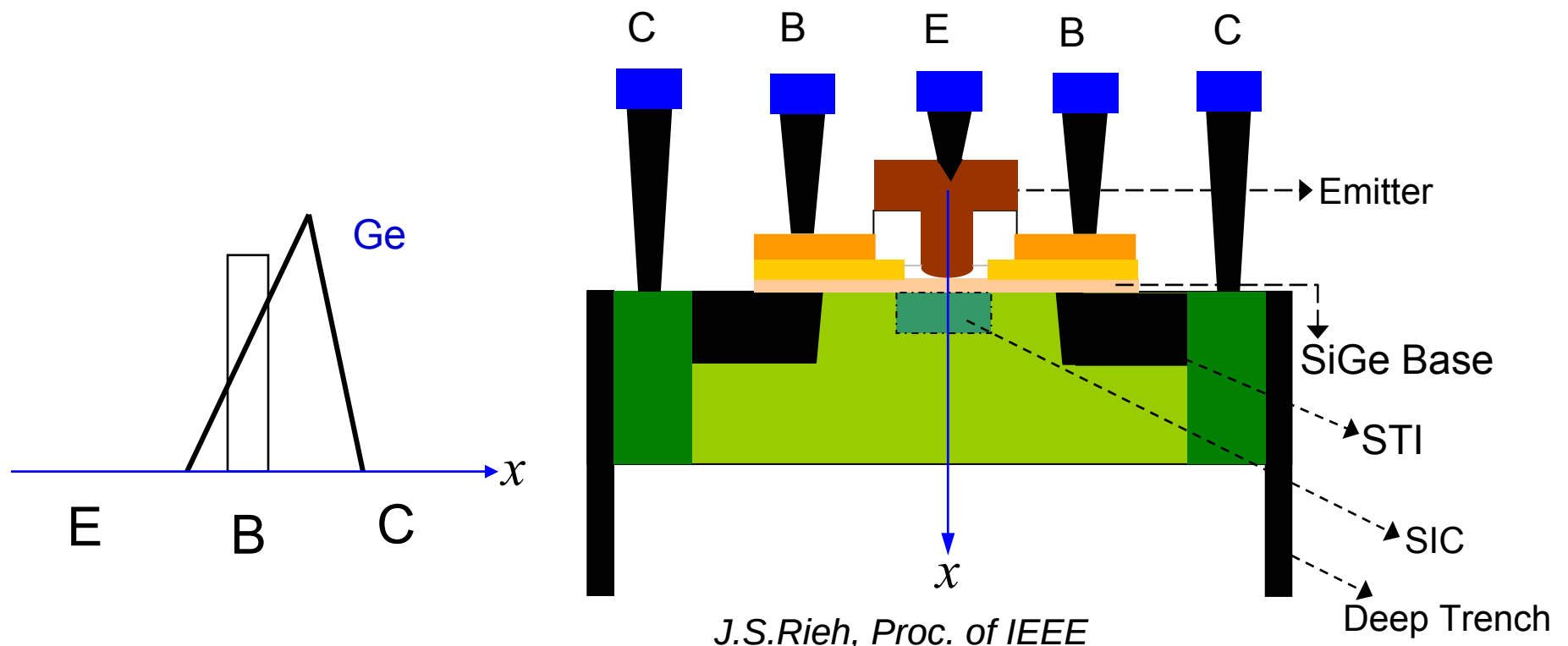
- 60 GHz ISM band
 - Wireless PAN
 - Large Available Bandwidth (57-64 GHz)
 - Potential for high data rates: 200Mb/s to > 1Gb/s
 - Point to Point links
- 77 GHz Automotive Radar Sensors

IBM's Vision for a Fully Integrated Packaged Low-cost SiGe MMW Transceiver

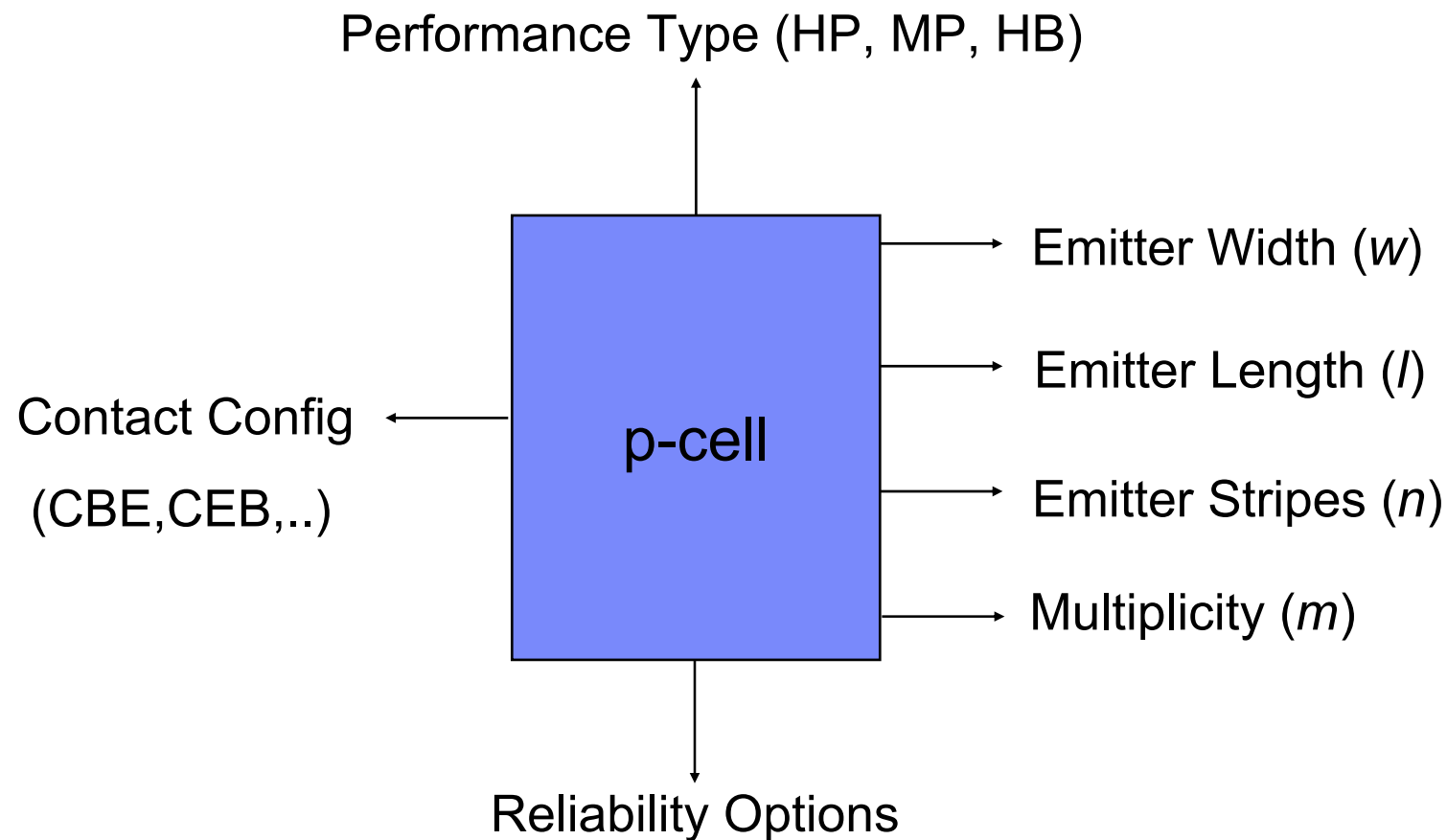


Structure of an Advanced SiGe HBT

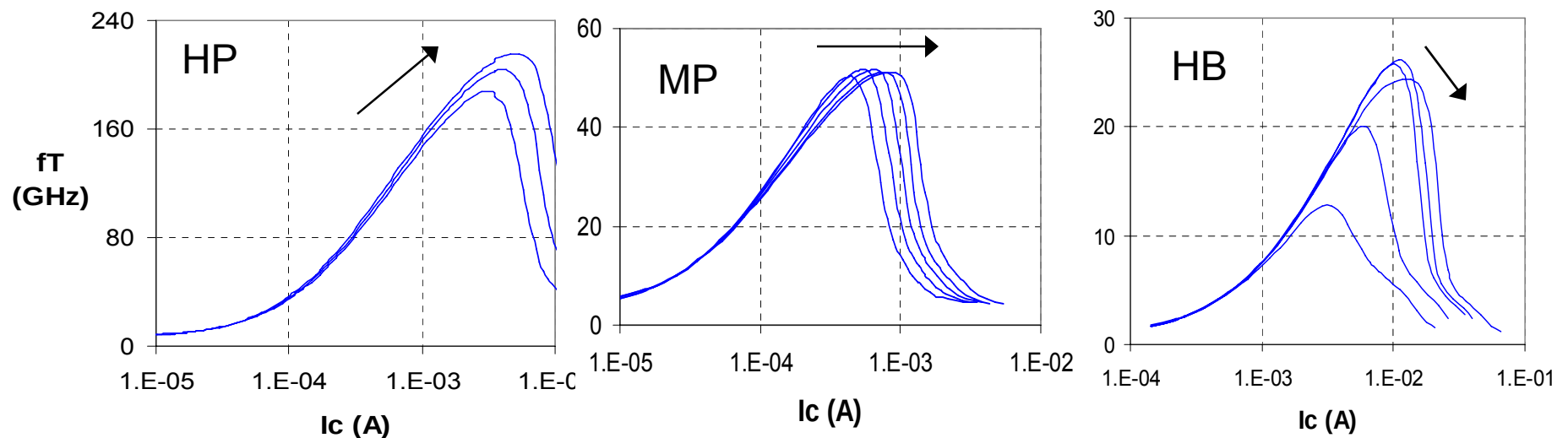
- Ge ramp and base thickness help in Speed
- SIC tailoring for Breakdown



Expected Scope of Model Scalability

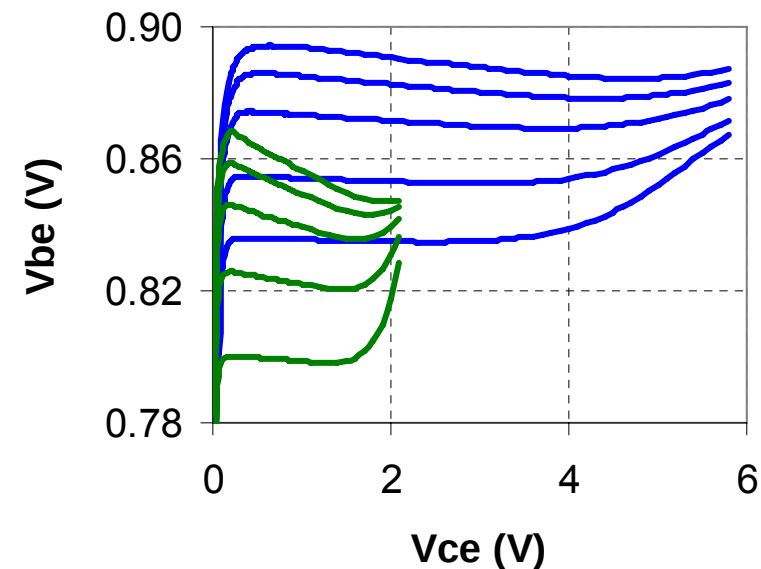
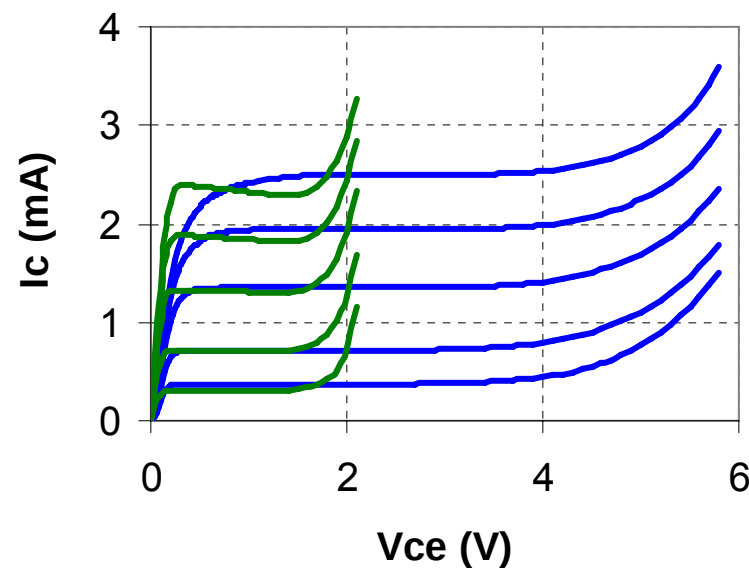


Variation of f_T - I_c with V_{cb}



- Depending on the collector profile, f_T may increase or decrease with V_{cb}
- Difficult to model this effect by Spice Gummel- Poon

Avalanche and Self-heating Regimes



- The BV_{CEO} spans a wide range in a given technology
- The effect of self-heating becomes severe in advanced HBTs
- Quasi-saturation modeling critical for applications using HB devices (eg. PAs)

HICUM (High-Current Model) Parameters for Extraction

	# of parameters
Terminal Resistances	4
Capacitances (BE, BC, CS C-V)	23
Saturation Currents (Fwd and Inverse, Ideal and non-ideal)	22
Low current transit time	3
High current transit time	10
Self-heating	2
Avalanche	2
Substrate Transistor/Substrate Network	7
Noise and NQS	5
Temperature coefficients	14

Methodology

<u>Test Structures:</u>	Transistors of various geometries Specialized Test Structures
<u>Measurements:</u>	DC, S-parameters (110GHz)
<u>Model:</u>	Hicum 2.1
<u>Parameter Extraction:</u>	Matlab
<u>Simulations:</u>	Spectre (Cadence)

- Scaling Equations are implemented in Spectre language in the model file

Junction Capacitance Extraction Flow

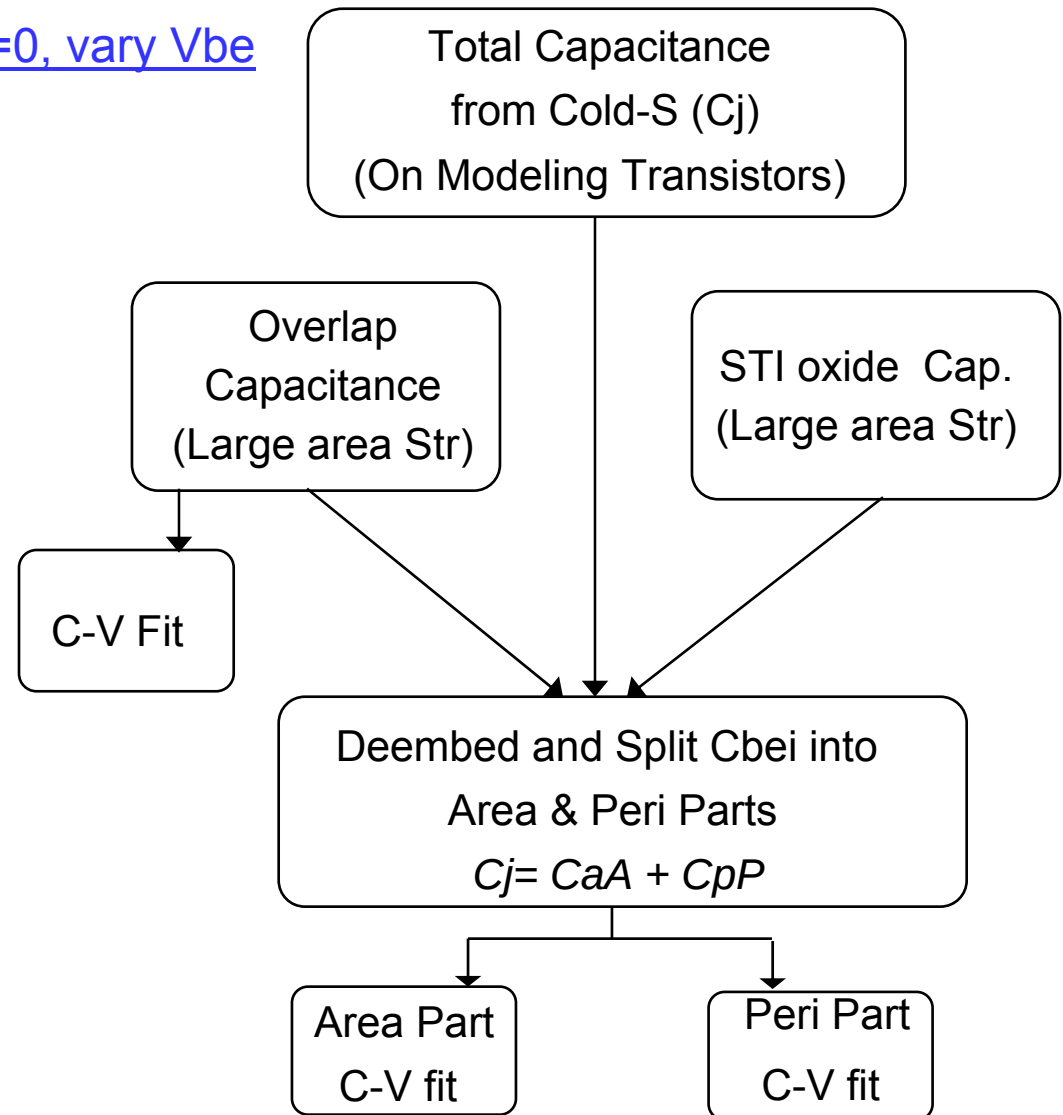
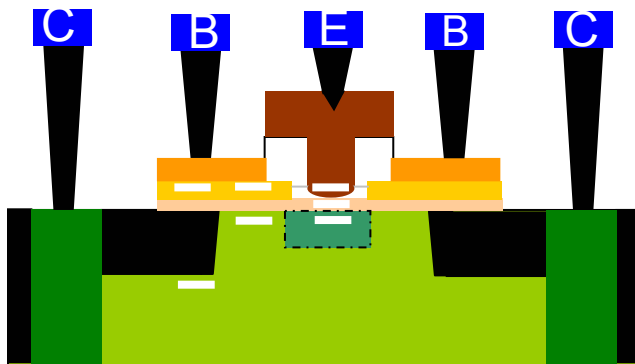
Cold-S: (i) $V_{be}=0$, vary V_{cb} (ii) $V_{cb}=0$, vary V_{be}

$$C_{be} = \frac{\text{imag}(Y_{11}) + \text{imag}(Y_{12})}{2\pi f}$$

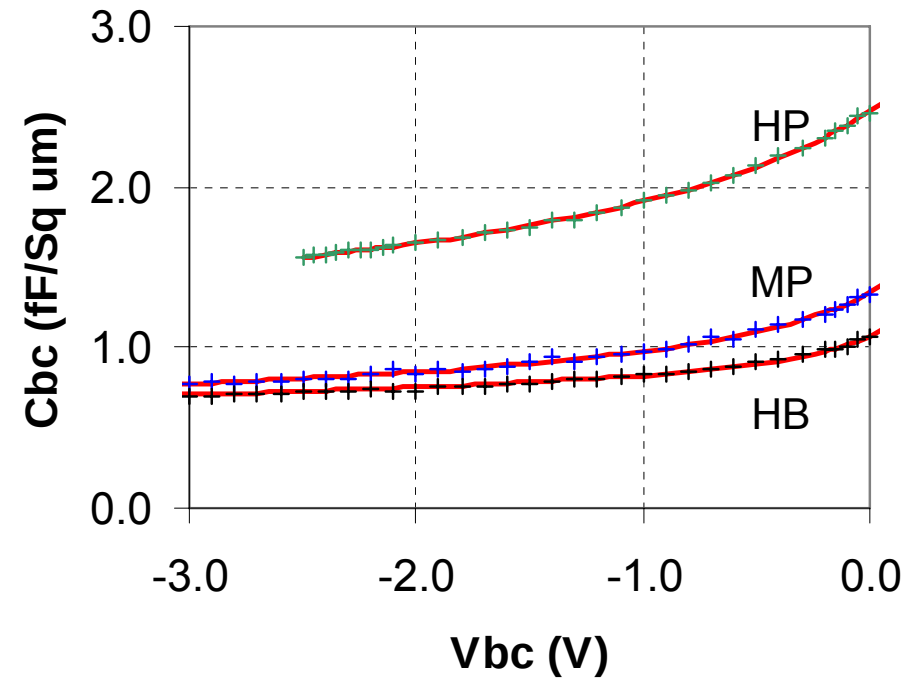
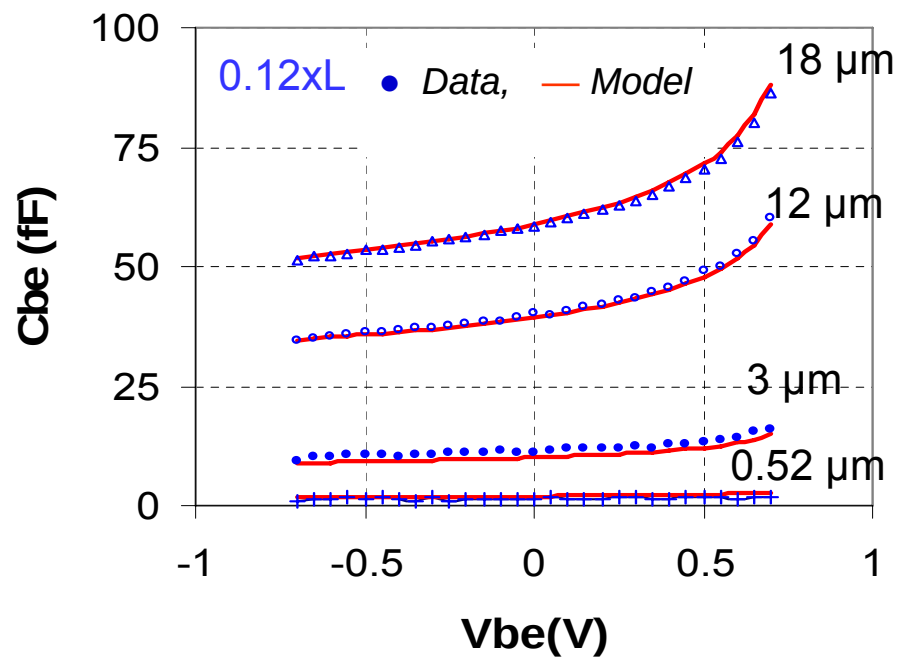
$$C_{bc} = -\frac{\text{imag}(Y_{12})}{2\pi f}$$

$$C_{cs} = -\frac{1}{2\pi f \cdot \text{imag}\left(\frac{1}{Y_{12} + Y_{22}}\right)}$$

$$R_{sub} = \text{real}\left(\frac{1}{Y_{12} + Y_{22}}\right)$$



Scaling of Junction Capacitances



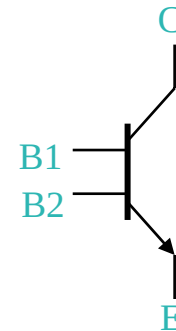
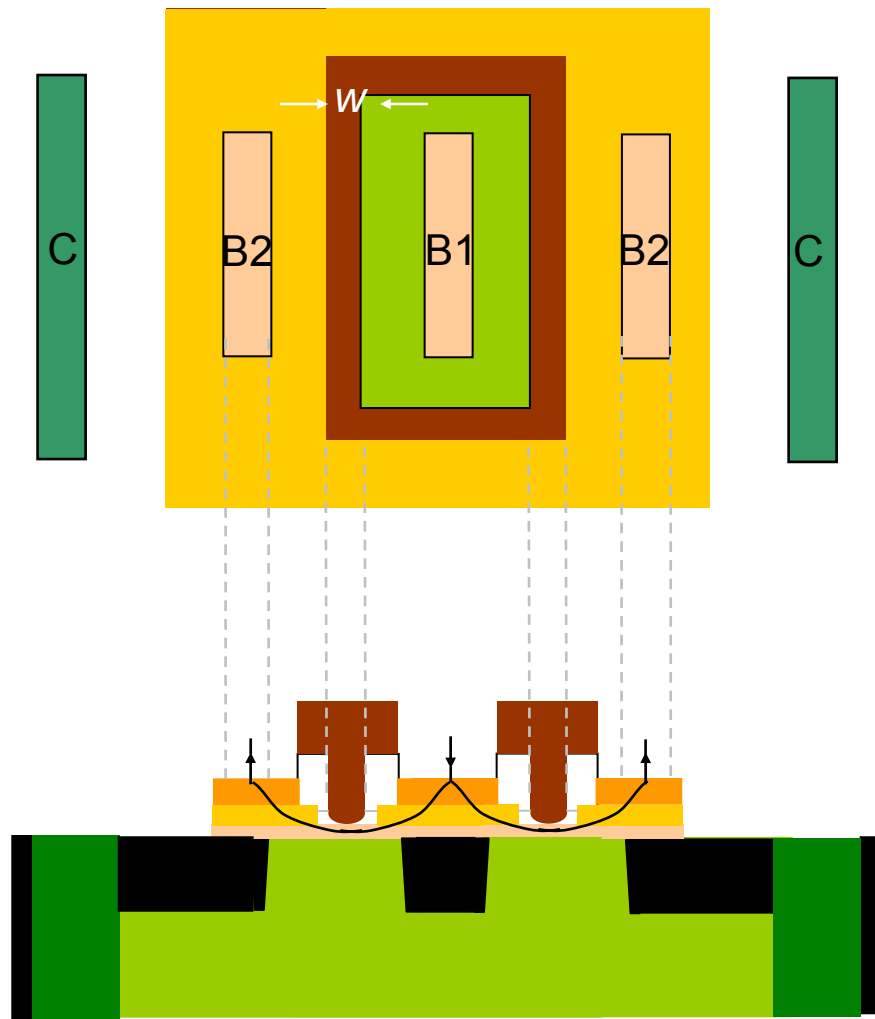
$$C = \frac{C_0}{(1 - V_j / V_{bi})^Z}$$

$$V_{bi} = kT \cdot \ln \left(\frac{n_{n0}}{n_{p0}} \right)$$

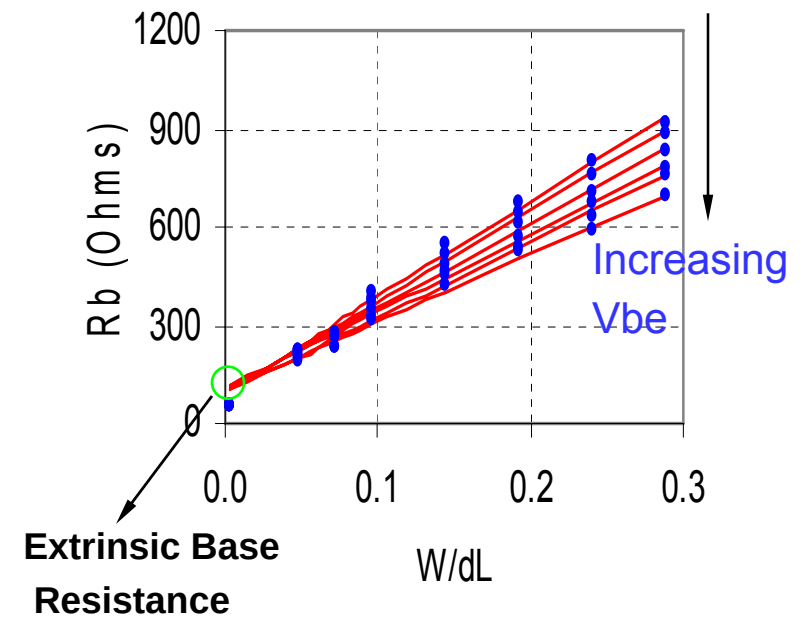
$$n_{n0} (HP) > n_{n0} (SP) > n_{n0} (HB)$$

$$V_{bi} = 0.95 V (HP), 0.65 V (SP), 0.55 V (HB)$$

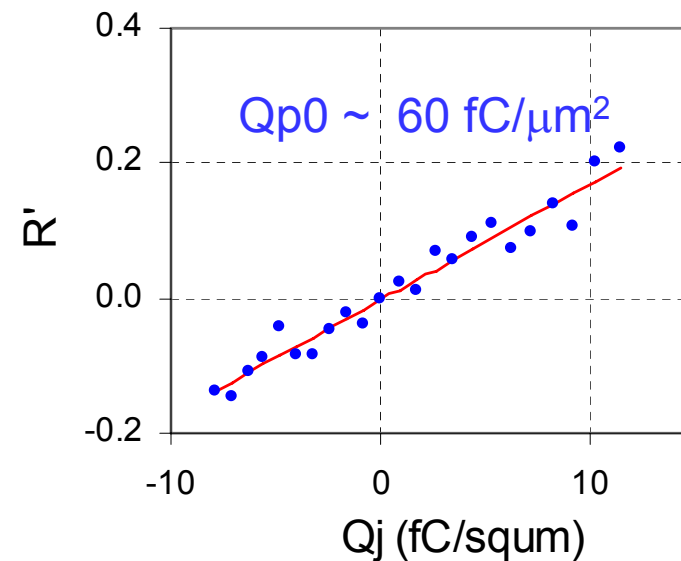
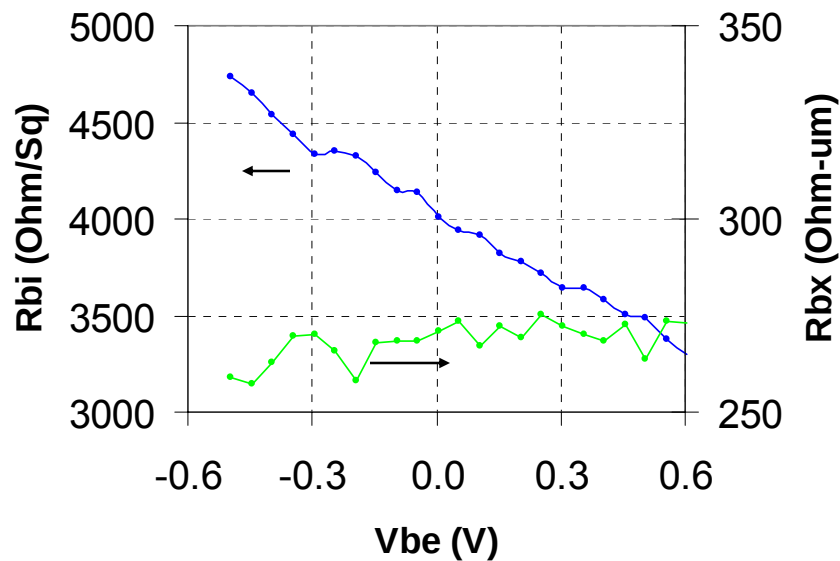
Base Resistance Test Structures



$$R_b = \frac{V_{B1,B2}}{\Delta I} = r_x + \frac{r_{bi}}{2} \frac{W}{\Delta L}$$

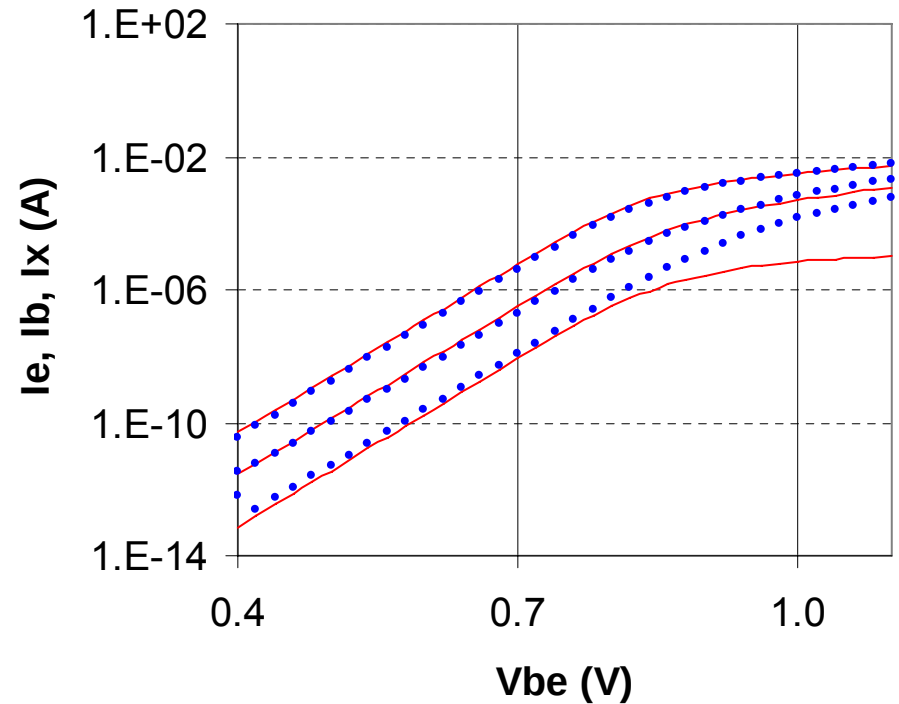
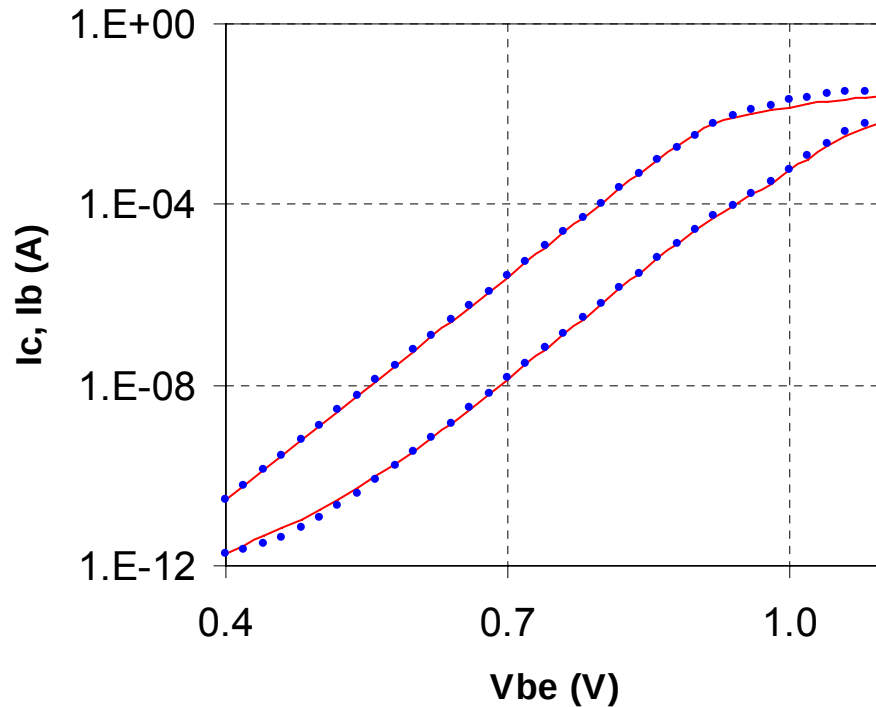


Bias Dependence of Base Resistance and Extraction of Zero-bias Hole Charge in the Base



$$\frac{1}{r_{bi}} = q \int_{x1}^{x2} \mu_p p dx \quad \longrightarrow \quad R' \equiv \frac{r_{bi0}}{r_{bi}} - 1 \approx \frac{Q_{jei} + Q_{jci}}{Q_{p0}}$$

Transfer Current: Forward and Reverse Gummels

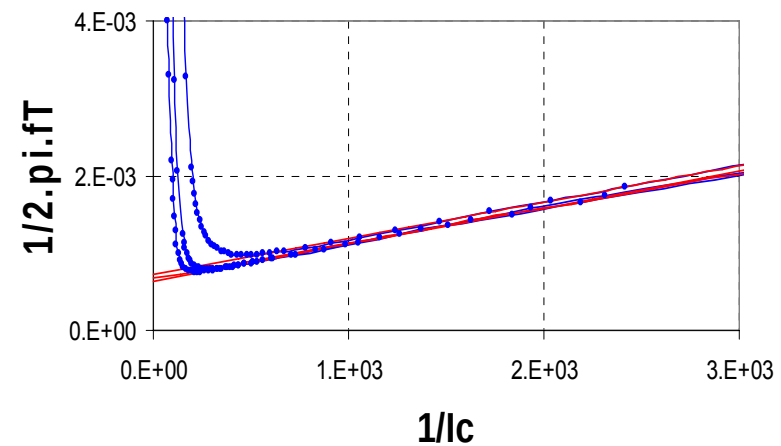
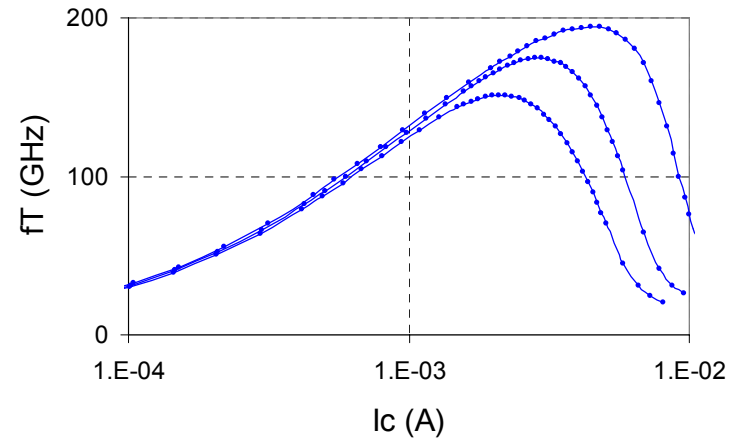


$$i_T = \frac{I_s}{Q_{pT} / Q_{p0}} \left[\exp \frac{V_{be}}{V_t} - \exp \frac{V_{bc}}{V_t} \right]$$

$$Q_{pT} = Q_{p0} + h_{jei} Q_{jei} + h_{jci} Q_{jci} + Q_{fT} + Q_{rT}$$

$$Q_{fT} = h_{fe} Q_{fe} + Q_{fb} + h_{fc} Q_{fc}$$

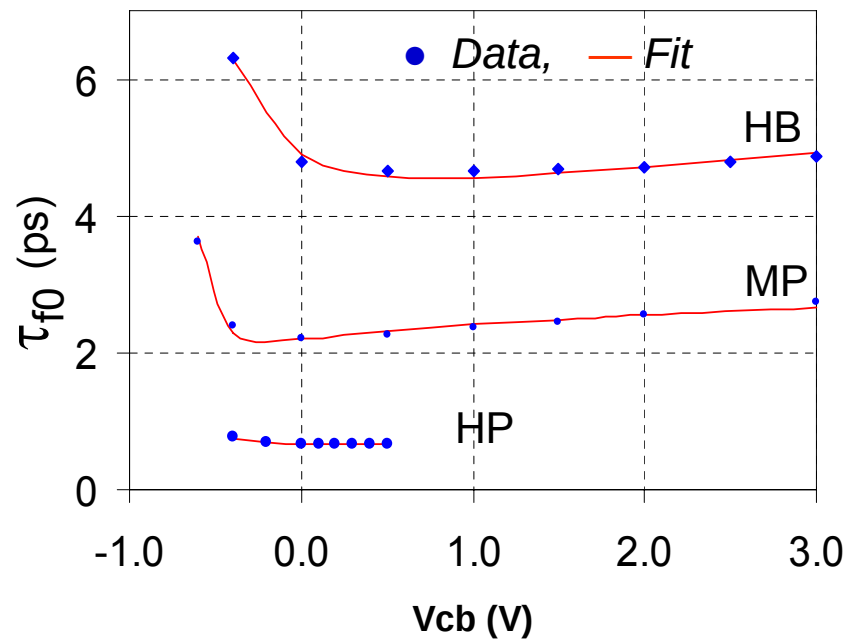
Extraction of Low Current Total Transit Time



$$\frac{1}{2\pi \cdot f_T} = \tau_f + (C_{je} + C_{jc}) \frac{V_T}{I_C} + (rcx + re) C_{jc}$$

$$\tau_f = \tau_{ec} = \tau_{Ef} + \tau_{BE} + \tau_B + \tau_{BC} + \tau_{pC}$$

Extraction of the Low Current Transit Time Components



$$\tau_{f0} = \tau_0 + \Delta\tau_{0h}(c - 1) + \tau_{bfl}\left(\frac{1}{c} - 1\right)$$

τ_0 = predominantly neutral base (not f(V))

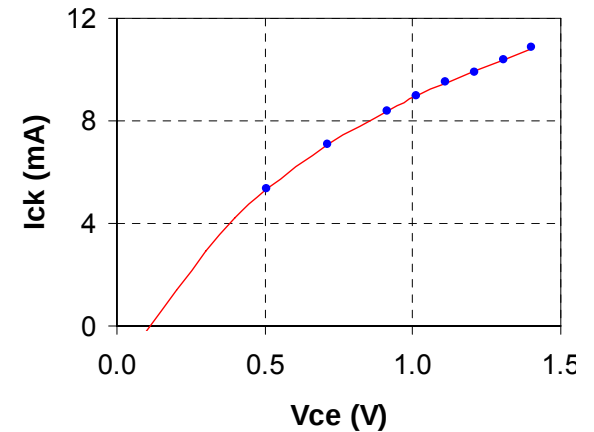
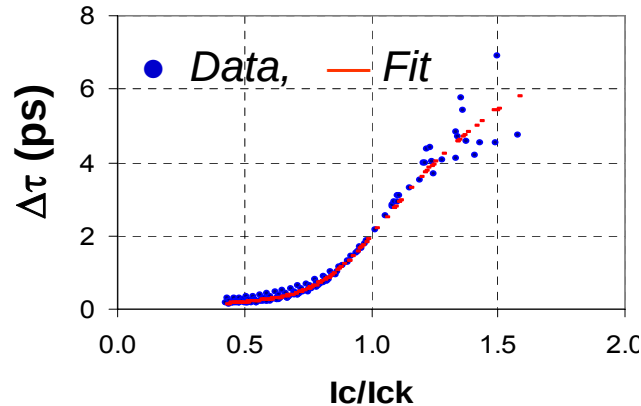
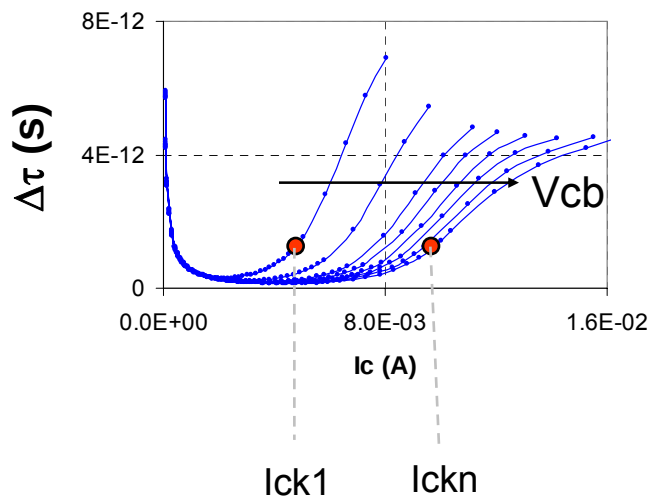
$$\Delta\tau_{0h} = \begin{cases} \text{BC SCR Component} \\ \text{Early Effect Component} \end{cases}$$

τ_{bfl} = carrier jam component

$$c = c_{jci0}/c_{jci}$$

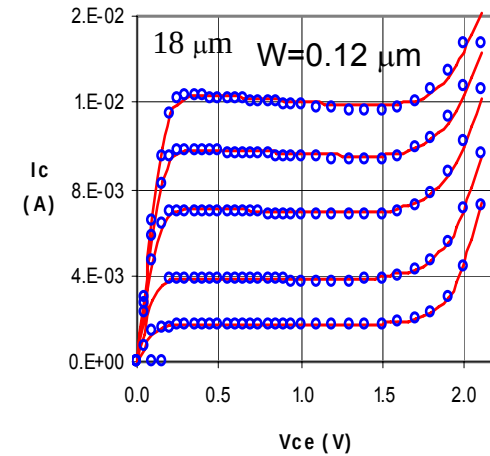
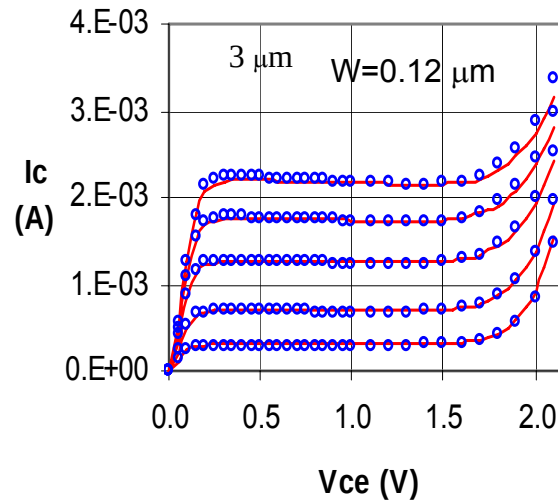
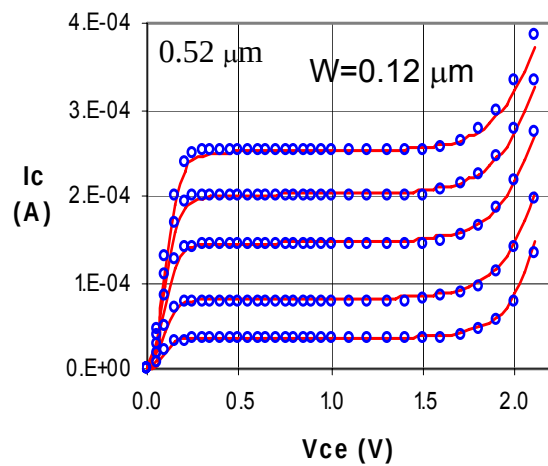
Extraction of the High Current Transit Time Parameters

- I_{ck} : critical current for the onset of high-current effects (base push-out)
- High-current part of the transit time: $\Delta\tau = \tau_f - \tau_{f0}$
- I_{ck} is determined graphically

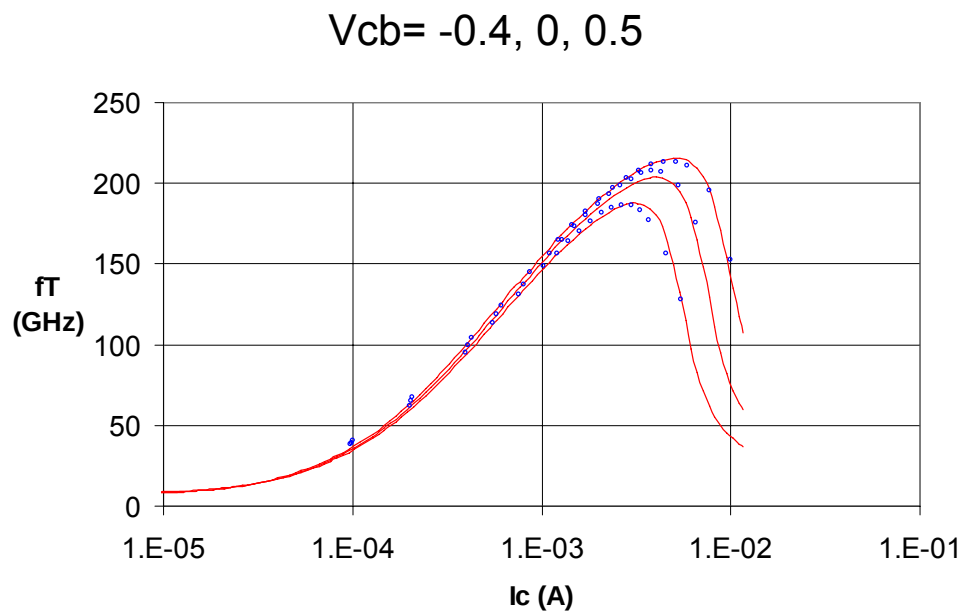


$$I_{ck} = \frac{V_{ce}'}{r_{ci0}} \frac{1}{\sqrt{1 + \left(\frac{V_{ce}'}{V_{lim}}\right)^2}} \left(1 + \frac{V_{ce}' - V_{lim}}{V_{PT}} \right)$$

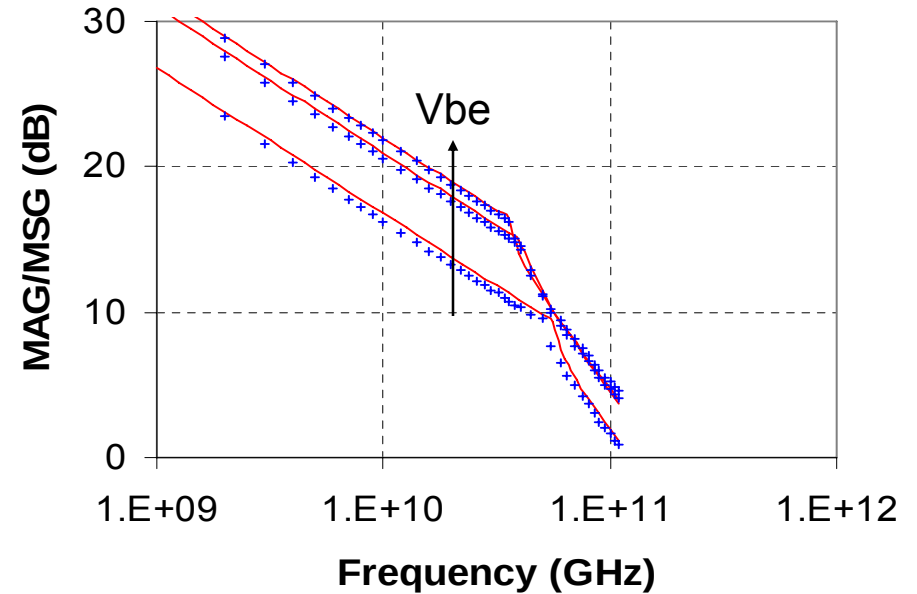
Geometry Scaling of the Output Curves



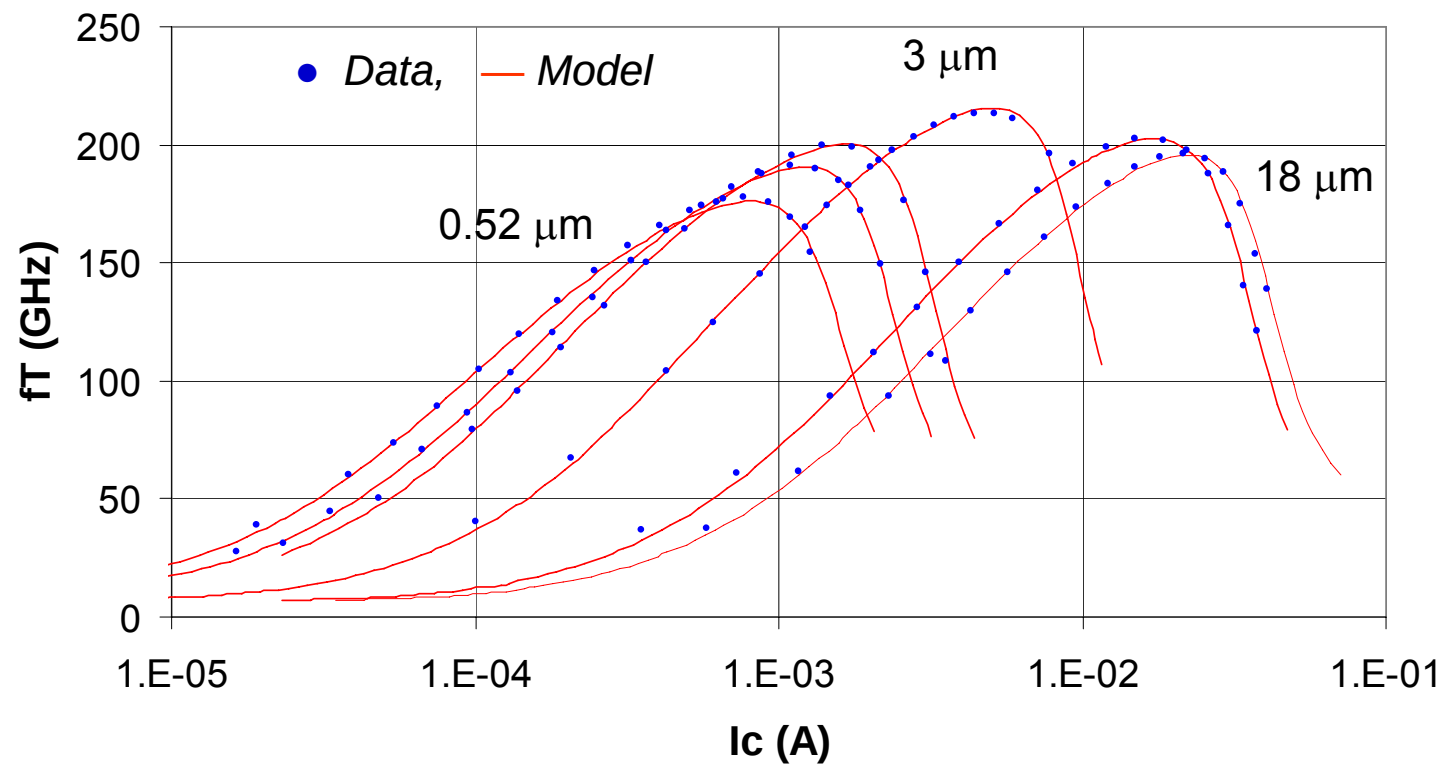
f_T - V_{cb} and MAG/MSG: Model vs Measurement



● Data, — Model



Geometry Scaling of fT-Ic



Noise Parameter Simulations

High Frequency Noise Parameter Simulations

- Simulated by SP (with noise) engine in Spectre

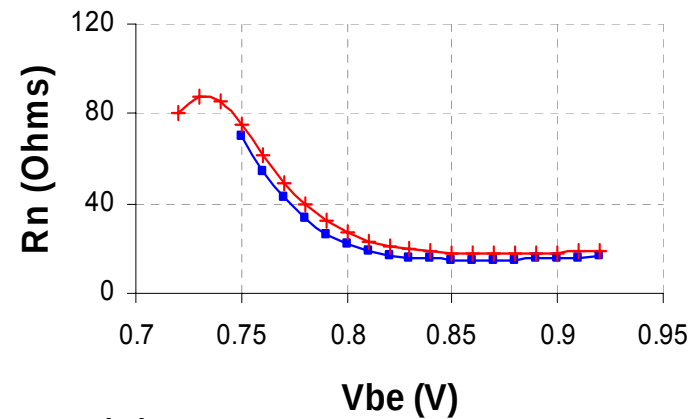
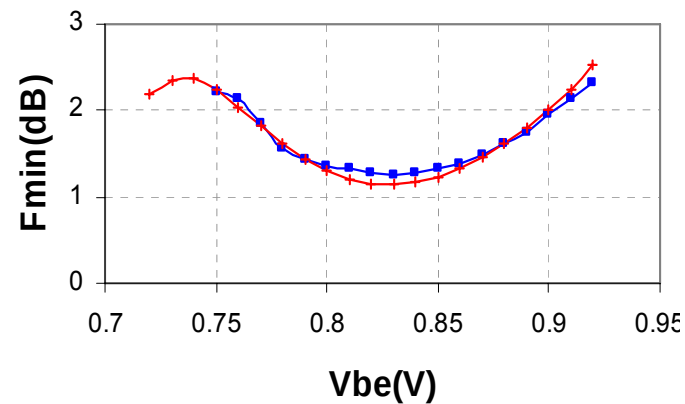
$$F = F_{\min} + \frac{R_n}{G_G} |Y_G - Y_{G,opt}|^2$$

$F_{\min}$: Minimum Noise Figure

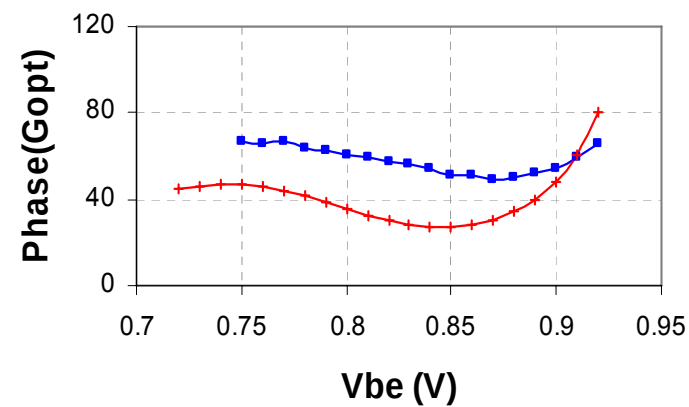
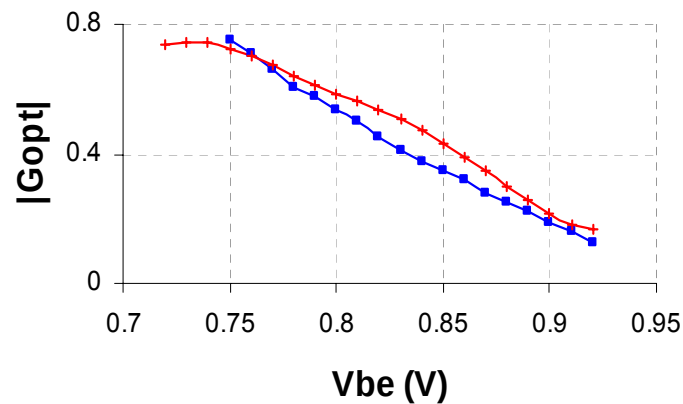
R_n : Noise Resistance

$Y_{G,opt}$: The optimum admittance to get minimum noise ($G_{G,opt} + jB_{G,opt}$)

Noise Parameters: Measurement vs Model (at 18 GHz)



● Data, — Model

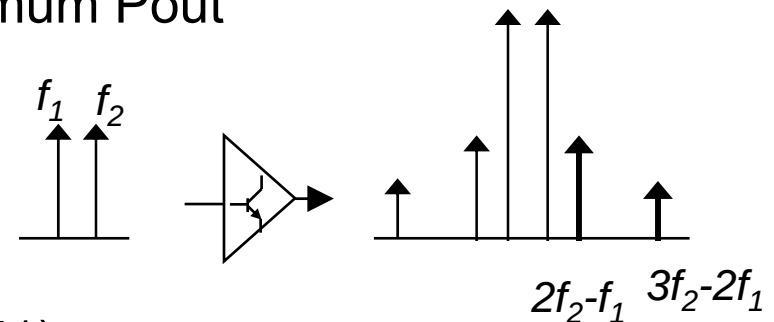


Linearity Measurements and Simulations

- Linearity simulations provide a good check to the accuracy of the model parameter set and model implementation in the simulator

Measurements

- Measurements done on an ATN Load pull system
- Tuned for Maximum PAE/ Maximum Pout
- $f_1=5$ GHz, $f_2 = 5.001$ GHz



Simulations

- Harmonic Balance in RFDE (IC51)
- QPSS in Spectre (IC51)
- Simulated 2-tone distortion behavior

Improved Rbi Implementation for Better Convergence-1

$$r_i = r_{bi0} \frac{q_0}{q_0 + \Delta q_p}, \text{ where } \Delta q_p = \Delta q_{jei} + \Delta q_{jci} + q_f$$

$$\Delta q_p \leq -q_0, \text{ leads to divide-by-zero errors}$$

We addressed this in ADS2005 by limiting Δq_p

$$\Delta q_p = q_{jei} + q_{jci} + q_f \quad \text{when} \quad \Delta q_p > q_{0\text{lim}}$$

$$\Delta q_p = q_{0\text{lim}}, \quad \text{when} \quad \Delta q_p \leq q_{0\text{lim}}$$

$$\text{where } q_{0\text{lim}} = -F * q_0, \quad 0 < F < 1.$$

A value of $F=0.75$ is found to provide a good trade-off between convergence and compatibility with the reference implementation.

Improved Rbi Implementation for Better Convergence-2

Hyperbolic smoothing is applied to the limiting function to eliminate derivative discontinuities at $q_{0\text{lim}}$ -

$$\Delta q_{p0} = q_{jei} + q_{jci} + q_f$$

$$\Delta q_p = q_{0\text{lim}} + \frac{1}{2} \left[\Delta q_{p0} - q_{0\text{lim}} + \sqrt{(\Delta q_{p0} - q_{0\text{lim}})^2 + \delta^2} \right]$$

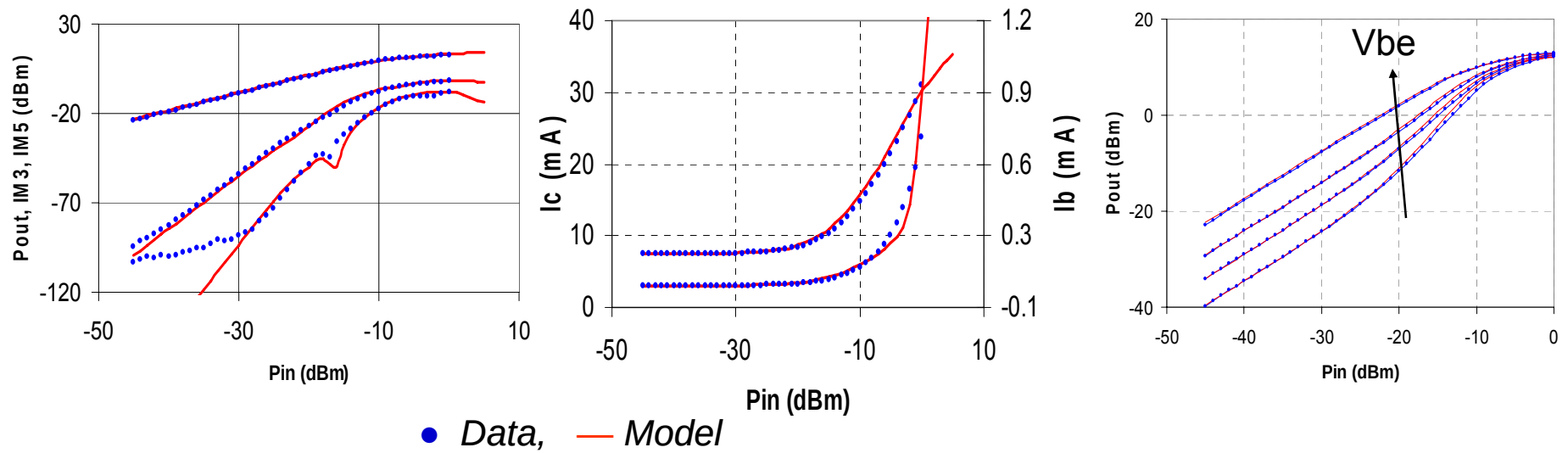
Where δ controls the trade-off between smoothness and accuracy. A good choice for δ is $\delta = 1e-3 * q_0$, where q_0 is the parameter describing the temperature-independent part of q_0 . Derivative expressions are altered as follows:

$$\frac{d\Delta q_p}{dV_{bei}} = \frac{d\Delta q_p}{dq_{p0}} \cdot \frac{d\Delta q_{p0}}{dV_{bei}},$$

$$\frac{d\Delta q_p}{dT} = \frac{d\Delta q_p}{dq_{0\text{lim}}} \cdot \frac{dq_{0\text{lim}}}{dT} + \frac{d\Delta q_p}{d\Delta q_{p0}} \cdot \frac{d\Delta q_{p0}}{dT}$$

Inter Modulation Distortion: Measurement vs Model

- Biased at $V_{be} = 0.86$ V, $V_{ce} = 1.36$ V, corresponds to 35% of peak f_T current
- Self-biasing effect is well captured
- Bias dependence is well modeled



Summary

- Most of the important parameters can be extracted by simple measurements and expressions and fitting routines
- Scaling of these parameters is technology and device layout dependent
- Hicup 2.1 is able to describe the device characteristics satisfactorily